

# Single N-channel MOSFET

## ELM4N18N20FTA-T

<https://www.elm-tech.com>

### ■General description

ELM4N18N20FTA-T uses advanced trench technology to provide excellent  $R_{ds(on)}$ , low gate charge and low gate threshold voltage.

### ■Features

- $V_{ds}=200V$
- $I_d=18A$  ( $V_{gs}=10V$ )
- $R_{ds(on)} = 170m\Omega$  ( $V_{gs}=10V$ )
- $R_{ds(on)} = 180m\Omega$  ( $V_{gs}=4.5V$ )

### ■Maximum absolute ratings

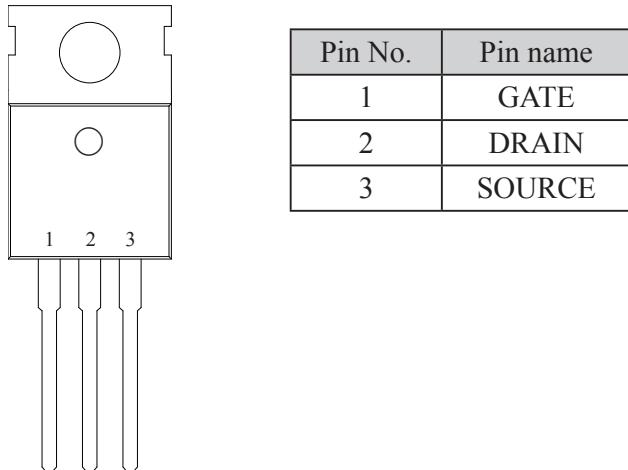
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	$V_{ds}$	200	V	
Gate-source voltage	$V_{gs}$	$\pm 20$	V	
Continuous drain current ( $V_{gs}=10V$ )	$I_d$	18.0	A	1
Tc=100°C		11.7		
Pulsed drain current	$I_{dm}$	40	A	2
Single pulse avalanche energy	$E_{as}$	15	mJ	3
Avalanche current	$I_{as}$	10	A	
Total power dissipation	$P_d$	83	W	4
Storage temperature range	$T_{stg}$	-55 to 150	°C	
Operating junction temperature range	$T_j$	-55 to 150	°C	

### ■Thermal characteristics

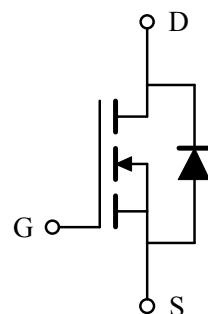
Parameter	Symbol	Typ.	Max.	Unit	Note
Thermal resistance junction-ambient	$R_{\theta ja}$	-	60.0	°C/W	1
Thermal resistance junction-case	$R_{\theta jc}$	-	1.1		

### ■Pin configuration

TO-220(TOP VIEW)



### ■Circuit



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### ■Electrical characteristics

T<sub>j</sub>=25°C. Unless otherwise noted.

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Note
<b>STATIC PARAMETERS</b>							
Drain-source breakdown voltage	BVdss	V <sub>gs</sub> =0V, I <sub>d</sub> =250μA	200	-	-	V	
Static drain-source on-resistance	R <sub>ds(on)</sub>	V <sub>gs</sub> =10V, I <sub>d</sub> =9A	-	-	170	mΩ	2
		V <sub>gs</sub> =4.5V, I <sub>d</sub> =9A	-	-	180		
Gate threshold voltage	V <sub>gs(th)</sub>	V <sub>gs</sub> =V <sub>ds</sub> , I <sub>d</sub> =250μA	1.2	-	2.5	V	
Drain-source leakage current	I <sub>dss</sub>	V <sub>ds</sub> =160V, V <sub>gs</sub> =0V	-	-	1	μA	
		V <sub>ds</sub> =160V, V <sub>gs</sub> =0V, T <sub>j</sub> =55°C	-	-	5		
Gate-source leakage current	I <sub>gss</sub>	V <sub>gs</sub> =±20V, V <sub>ds</sub> =0V	-	-	±100	nA	
Forward transconductance	G <sub>fs</sub>	V <sub>ds</sub> =5V, I <sub>d</sub> =9A	-	22	-	S	
Continuous source current	I <sub>s</sub>	V <sub>gs</sub> =V <sub>ds</sub> =0V, Force current	-	-	18	A	1, 5
Pulsed source current	I <sub>sm</sub>		-	-	40	A	2, 5
Diode forward voltage	V <sub>sd</sub>	V <sub>gs</sub> =0V, I <sub>s</sub> =1A	-	-	1.2	V	2
<b>DYNAMIC PARAMETERS</b>							
Input capacitance	C <sub>iss</sub>	V <sub>ds</sub> =25V, V <sub>gs</sub> =0V, f=1MHz	-	2047	-	pF	
Output capacitance	C <sub>oss</sub>		-	109	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	70	-	pF	
Gate resistance	R <sub>g</sub>	V <sub>ds</sub> =0V, V <sub>gs</sub> =0V, f=1MHz	-	2	-	Ω	
<b>SWITCHING PARAMETERS</b>							
Total gate charge (10V)	Q <sub>g</sub>	V <sub>ds</sub> =80V, V <sub>gs</sub> =10V, I <sub>d</sub> =9A	-	45.0	-	nC	
Gate-source charge	Q <sub>gs</sub>		-	9.0	-	nC	
Gate-drain charge	Q <sub>gd</sub>		-	10.5	-	nC	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>ds</sub> =50V, V <sub>gs</sub> =10V R <sub>gen</sub> =3.3Ω, I <sub>d</sub> =9A	-	13.0	-	ns	
Turn-on rise time	t <sub>r</sub>		-	8.2	-	ns	
Turn-off delay time	t <sub>d(off)</sub>		-	25.0	-	ns	
Turn-off fall time	t <sub>f</sub>		-	11.0	-	ns	
Reverse recovery time	t <sub>rr</sub>		-	37	-	nS	
Reverse recovery charge	Q <sub>rr</sub>	If=10A, di/dt=100A/μs	-	103	-	nC	

### NOTE :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width ≤ 300μs and duty cycle ≤ 2%.
3. The EAS data shows Max. rating . The test condition is V<sub>ds</sub>=25V, V<sub>gs</sub>=10V, L=0.3mH, I<sub>as</sub>=10A.
4. The power dissipation is limited by 150°C junction temperature.
5. The data is theoretically the same as I<sub>d</sub> and I<sub>dm</sub>, in real applications, should be limited by total power dissipation.

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## ■Typical characteristics

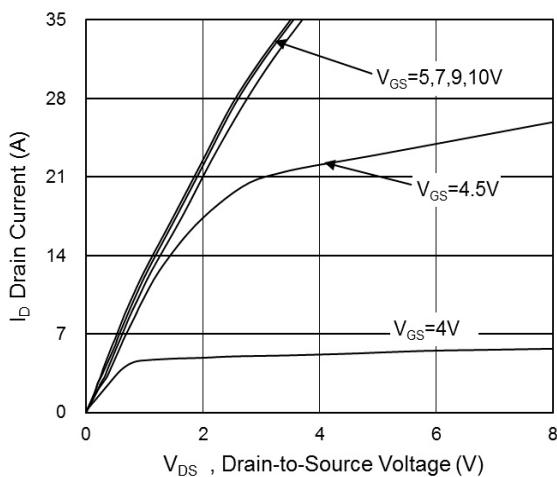


Fig.1 Typical Output Characteristics

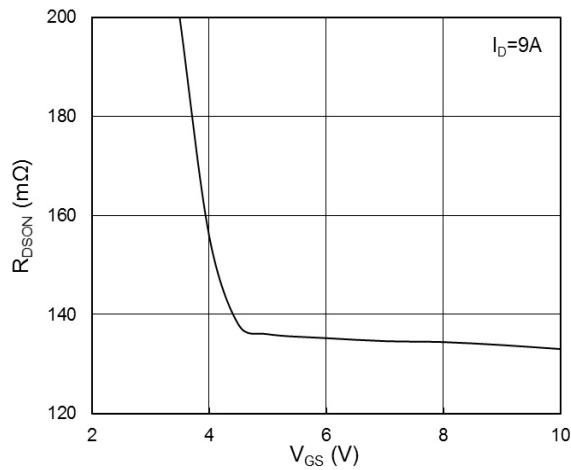


Fig.2 On-Resistance vs. Gate-Source

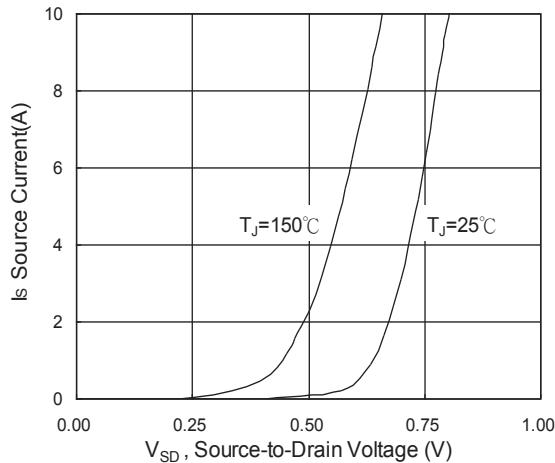


Fig.3 Forward Characteristics Of Reverse

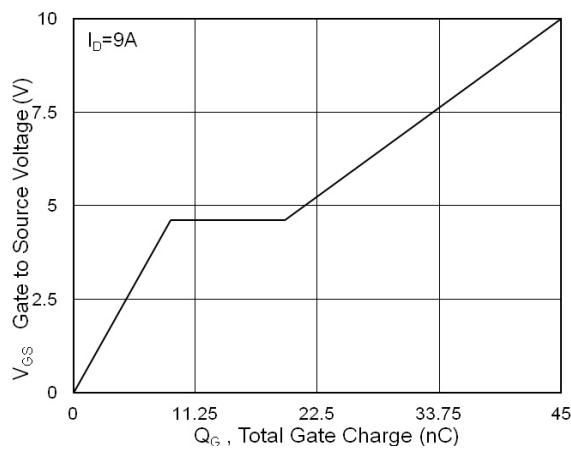


Fig.4 Gate-Charge Characteristics

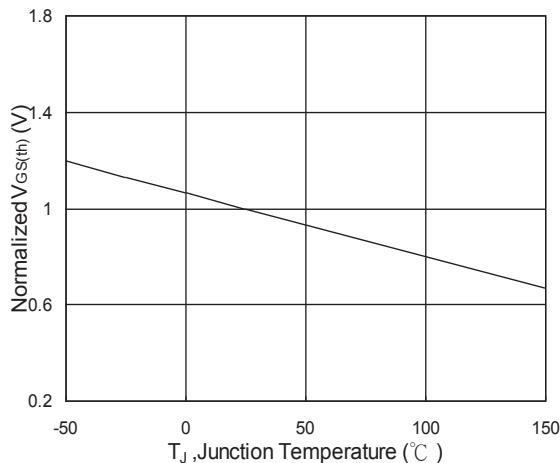


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$

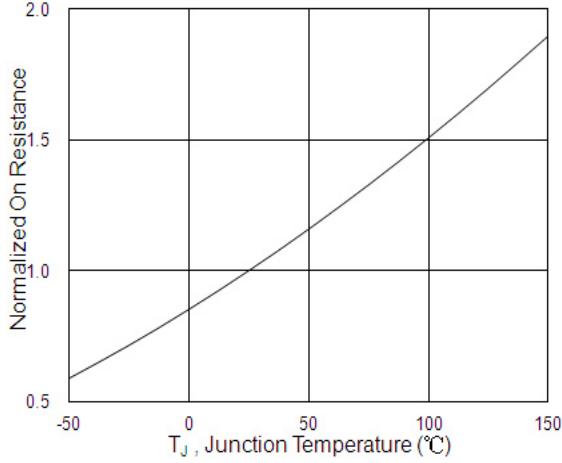


Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$

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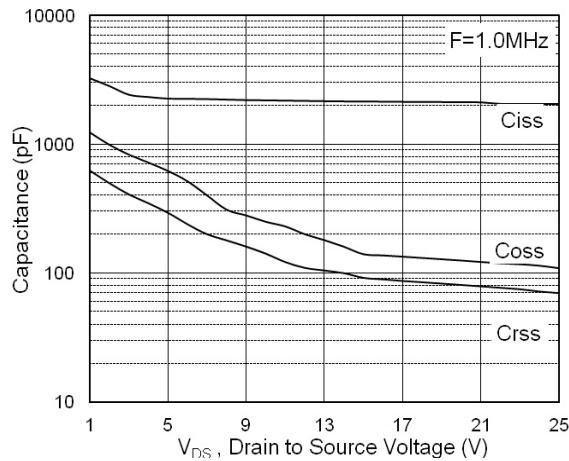


Fig.7 Capacitance

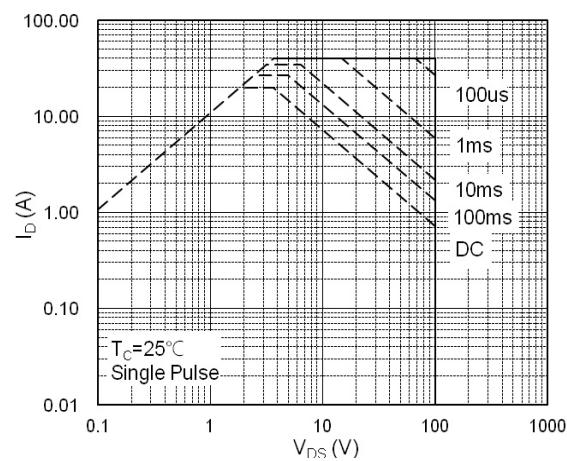


Fig.8 Safe Operating Area

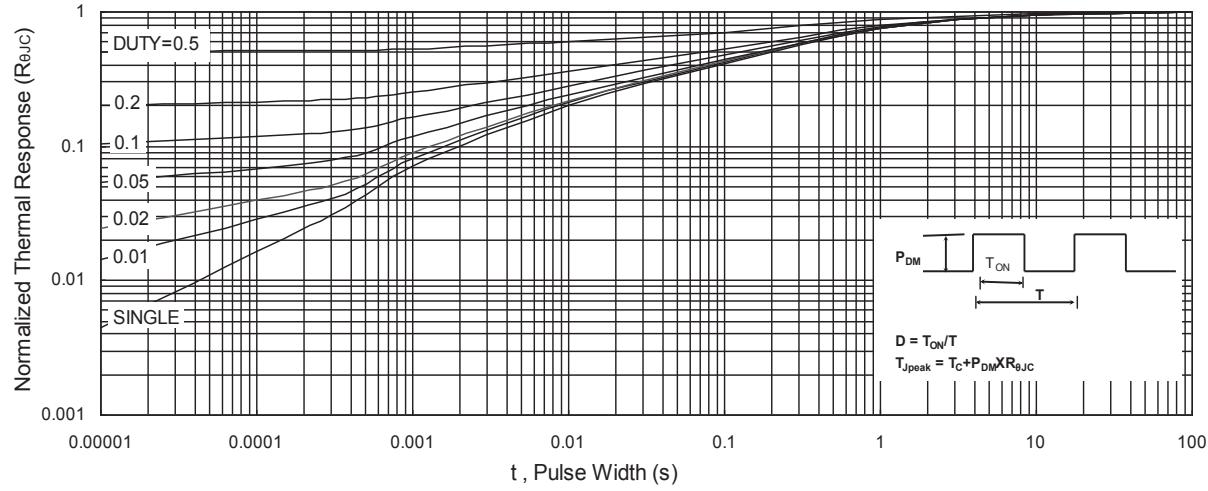


Fig.9 Normalized Maximum Transient Thermal Impedance

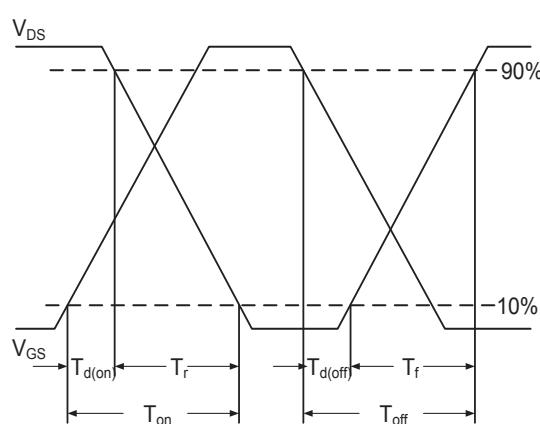


Fig.10 Switching Time Waveform

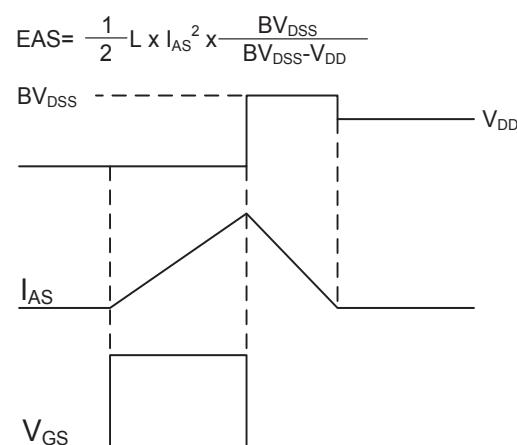


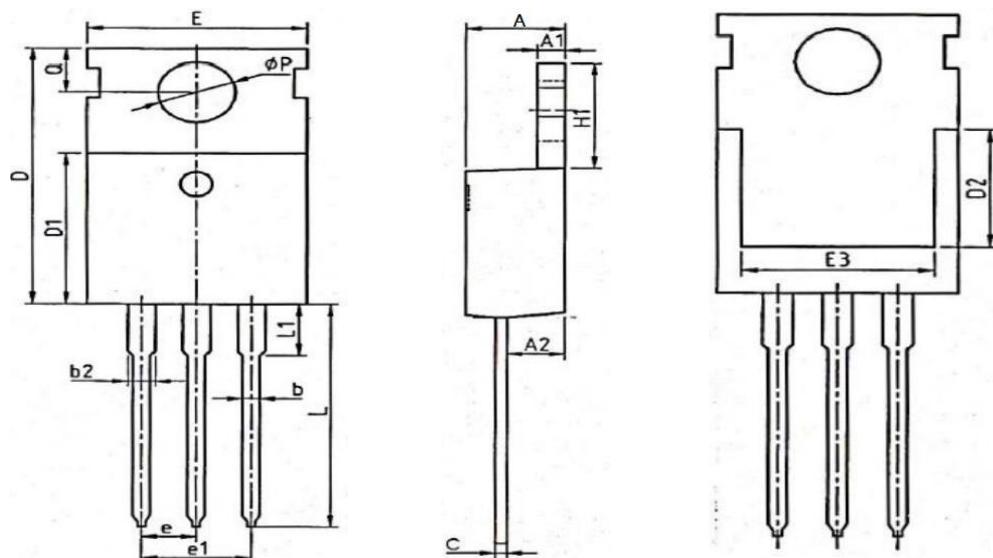
Fig.11 Unclamped Inductive Switching Waveform

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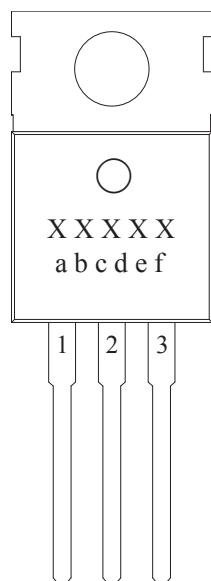
<https://www.elm-tech.com>

## ■TO-220 dimension (50pcs/tube)



Symbols	Millimeters		Inches		Symbols	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	3.556	4.826	0.140	0.190	E	9.652	10.668	0.380	0.420
A1	0.508	1.400	0.020	0.055	E3	6.858	--	0.270	--
A2	2.032	2.921	0.080	0.115	e	2.540 BSC		0.100 BSC	
b	0.381	1.016	0.015	0.040	e1	5.080 BSC		0.200 BSC	
b2	1.143	1.778	0.045	0.070	H1	5.842	6.858	0.230	0.270
c	0.356	0.610	0.014	0.024	L	12.700	14.732	0.500	0.580
D	14.224	16.510	0.560	0.650	L1	--	4.060	--	0.160
D1	8.382	9.017	0.330	0.355	Q	2.540	3.048	0.100	0.120
D2	5.500	--	0.216	--	Ø	3.400	3.800	0.130	0.150

## ■Marking



Symbols	Content
xxxxx	Product code
a	Yearly code : 2019=K, 2020=L, 2021=M ...
b, c	Weekly code : 01 to 53
d, e	Sequence : 01 to 99 or 0A to 0Z
f	Assembly code : A to Z (I, O excepted)